





Electrical Characteristics: (at 25°C)

Test Condition		_	
100kHz 0.25V	L	0.33µH ± 20%	
at 25°C	DCR	8mΩ (Max.)	
100kHz 0.25V IRMS = 12A	ΔΤ	Temperature rise 40°C (Max.)	
Operating temperature	-55°C to +130°C		

Material List:

No.	Item	Material Description
1	Core	R5A CDR5.8 × 4.5(ST) B3.5 F2.3
2	Wire	Ф0.45mm × 1P 2UEWF 155°C
3	Solder(Lead Free)	Sn99.3% / Cu0.7%

Reliability Test:

Test Items	Specifications	Test Method and Remarks		
Operating temperature range	–55°C to +130°C	Including temperature rise due to self generated heat		
Storage Condition	Ambient Temp. : 0°C to 40°C Humidity : Below 70%RH	To maintain the solderability of terminal electrodes, care must be taken to control temperature and humidity in the storage area.		
Moisture Sensitivity	Appearance : No abnormality No Damage DCR change : within ±20% Inductance change : within ±20%	According to J-STD-020B level 3 Test condition : 60°C 60%RH Test duration : 40hrs Recovery : 1 to 2hrs of recovery under the standard condition after the removal from the test chamber.		
Solderability	All termination shall exhibit a continuous solder coating free from defects for a minimum of 90% of the surface area of any individual lead.	According to J-STD-002B Steam aging category : 97°C 98%RH Steam aging duration : 8hrs Solder : Lead-free solder Solder temperature : 260 ±5°C Dip time : 5 +0/-0.5 seconds		





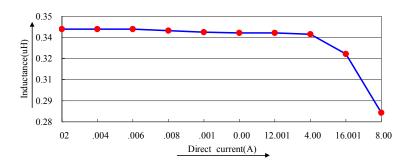
Test Data for Mechanical:

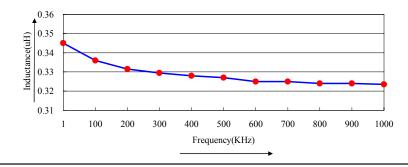
Test Item	A (mm)	B (mm)	C (mm)	D (mm)	E (mm)
Spec	5.2 ±0.3	5.8 ±0.3	4.5 ±0.4	2 (Ref)	5.8 ±0.5
1	5.26	5.87	4.52	2.02	5.85
2	5.28	5.88	4.54	2.03	5.83
3	5.24	5.85	4.55	1.96	5.85
4	5.26	5.86	4.51	1.98	5.91
5	5.27	5.84	4.52	2.01	5.87
Average	5.26	5.86	4.53	2	5.86

Test Data for Electrical:

Test Item	L μH	DCR mΩ	ΔΤ
Condition	100kHz 0.25V	at 25°C	100kHz 0.25V I _{RMS} = 12A
Spec	0.33 ±20%	8 (Max.)	Temperature rise 40°C (Max.)
1	0.322	6.09	
2	0.32	6.27	
3	0.327	6.13	ОК
4	0.329	6.15	
5	0.321	6.07	
Average	0.32	6.14	ОК

Electrical Characteristics:



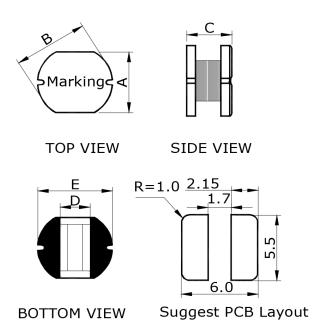


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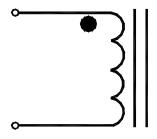


Configurations & Dimensions:



Α	5.2 ±0.3mm
В	5.8 ±0.3mm
С	4.5 ±0.35mm
D	2 (REF) mm
E	5.8 ±0.5mm

Schematic Diagram:



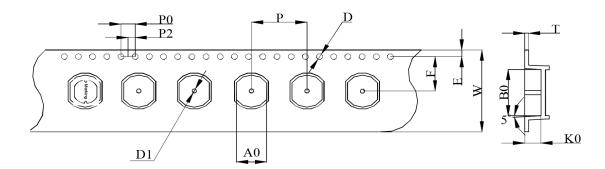
Note: 1.Wire Φ0.45mm × 1P 2UEWF 155°C 2. 3.5TS(REF)





Package Specification:

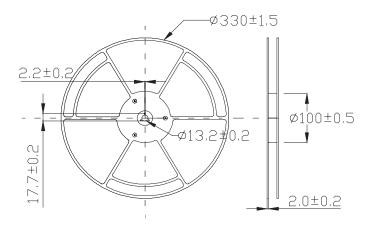
Encapsulation Mode



Р	P0	P2	D	D1	Е	F	W	В0	K0	A0	Т
8 ±1	4 ±0.1	2 ±0.1	1.5 +0.15/-0	1.5 (min)	1.75 ±0.1	7.5 ±0.1	16 +0.3/-0.1	6.4 ±0.1	5.1 ±0.1	5.5 ±0.1	0.5 ±0.05

Dimensions: Millimetres

Reel Size:



Dimensions: Millimetres

Part Number Table

Description	Part Number		
SMD Power Inductor, 0.33µH, ±20%	MCSD54-R33MU		

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